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## LM3708/LM3709 Microprocessor Supervisory Circuits with Low Line Output, Manual Reset and Watchdog Timer

Check for Samples: [LM3708](#), [LM3709](#)

### FEATURES

- Standard Reset Threshold Voltage: 3.08V
- Custom Reset Threshold Voltages: For Other Voltages between 2.2V and 5.0V in 10mV Increments, Contact TI.
- No External Components Required
- Manual-Reset Input
- **RESET (LM3708) or RESET (LM3709) Outputs**
- Precision Supply Voltage Monitor
- Factory Programmable Reset and Watchdog Timeout Delays
- Available in DSBGA Package for Minimum Footprint
- $\pm 0.5\%$  Reset Threshold Accuracy at Room Temperature
- $\pm 2\%$  Reset Threshold Accuracy Over Temperature Extremes
- Reset Assertion down to 1V  $V_{CC}$  (**RESET Option Only**)
- 28  $\mu$ A  $V_{CC}$  Supply Current

### DESCRIPTION

The LM3708/LM3709 series of microprocessor supervisory circuits provide the maximum flexibility for monitoring power supplies and battery controlled functions in systems without backup batteries. The LM3708/LM3709 series are available in a 9-bump DSBGA package.

Built-in features include the following:

Reset: Reset is asserted during power-up, power-down, and brownout conditions. RESET is specified down to  $V_{CC}$  of 1.0V.

Manual Reset Input: An input that asserts reset when pulled low.

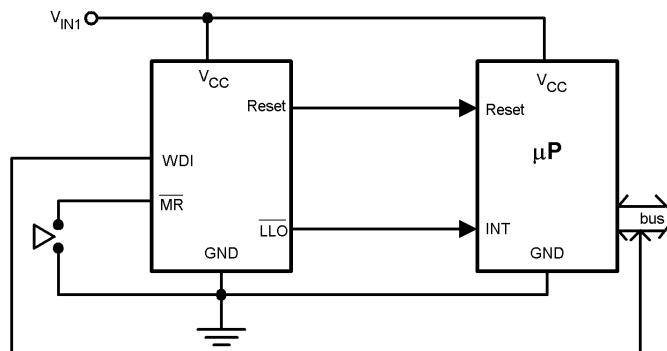
Low Line Output: This early power failure warning indicator goes low when the supply voltage drops to a value which is 2% higher than the reset threshold voltage.

Watchdog Timer: The WDI (Watchdog Input) monitors one of the  $\mu$ P's output lines for activity. If no output transition occurs during the watchdog timeout period, reset is activated.

### APPLICATIONS

- Embedded Controllers and Processors
- Intelligent Instruments
- Automotive Systems
- Critical  $\mu$ P Power Monitoring

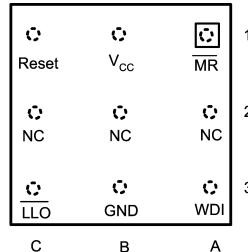
### Typical Application



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## Connection Diagram

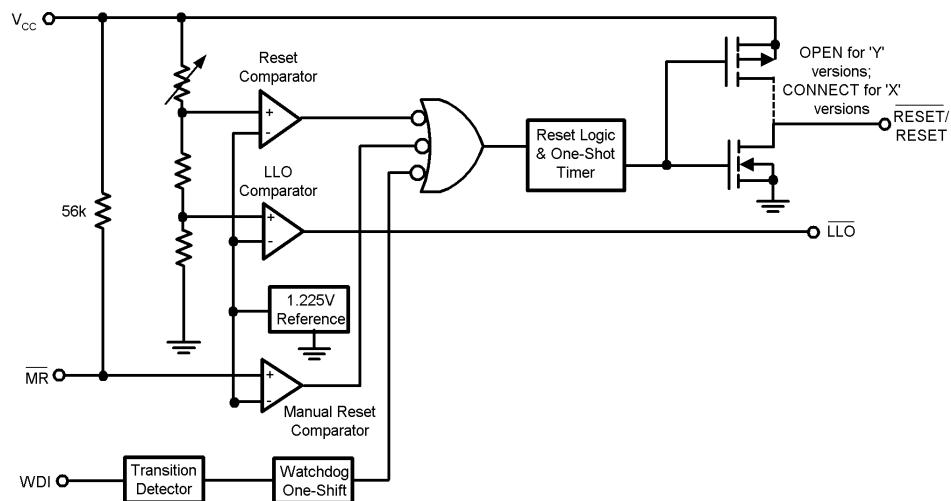


**Figure 1. Top View  
(looking from the coating side)  
DSBGA 9 Bump Package  
BPA09**

## PIN DESCRIPTIONS

Bump No.	Name	Function
A1	$\overline{MR}$	Manual-Reset input. When $\overline{MR}$ is less than $V_{MRT}$ (Manual Reset Threshold) $\overline{RESET/RESET}$ is engaged.
B1	$V_{CC}$	Power Supply input.
C1	RESET	Reset Logic Output. Pulses low for $t_{RP}$ (Reset Timeout Period) when triggered, and stays low whenever $V_{CC}$ is below the reset threshold or when $MR$ is below $V_{MRT}$ . It remains low for $t_{RP}$ after either $V_{CC}$ rises above the reset threshold, or after $MR$ input rises above $V_{MRT}$ (LM3708 only).
	RESET	Reset Logic Output. RESET is the inverse of $\overline{RESET}$ (LM3709 only).
C3	$\overline{LLO}$	Low-Line Logic Output. Early Power-Fail warning output. Low when $V_{CC}$ falls below $V_{LLOT}$ (Low-Line Output Threshold). This output can be used to generate an NMI (Non-Maskable Interrupt) to provide an early warning of imminent power-failure.
B3	GND	Ground reference for all signals.
A3	WDI	Watchdog Input Transition Monitor: If no transition activity occurs for a period exceeding $t_{WD}$ (Watchdog Timeout Period), reset is engaged.
A2, C2	NC	No Connect.
B2	NC	No Connect. Test input used at factory only. Leave floating.

## Block Diagram



**Table 1. Table Of Functions**

Part Number	Active Low Reset	Active High Reset	Output (X = totem-pole) (Y = open-drain)	Reset Timeout Period	Watchdog Timeout Period	Manual Reset	Low Line Output
LM3708	x		X, Y <sup>(1)</sup>	Customized	Customized	x	x
LM3709		x	X	Customized	Customized	x	x

(1) = available upon request. Contact TI



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### ABSOLUTE MAXIMUM RATINGS<sup>(1)(2)</sup>

Supply Voltage (V <sub>CC</sub> )	-0.3V to 6.0V	
All Other Inputs	-0.3V to V <sub>CC</sub> + 0.3V	
ESD Ratings <sup>(3)</sup>	Human Body Model	1.5kV
	Machine Model	150V
Power Dissipation	See <sup>(4)</sup>	

- Absolute Maximum Ratings** indicate limits beyond which damage to the device may occur. **Operating Ratings** indicate conditions for which the device is intended to be functional, but do not ensure specific performance limits. For ensured specifications and test conditions, see the Electrical Characteristics. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed conditions.
- If Military/Aerospace specified devices are required, please contact the TI Sales Office/ Distributors for availability and specifications.
- The Human Body model is a 100 pF capacitor discharged through a 1.5 kΩ resistor into each pin. The machine model is a 200pF capacitor discharged directly into each pin.
- The maximum allowable power dissipation is a function of the maximum junction temperature, T<sub>J</sub>(MAX), the junction-to-ambient thermal resistance, θ<sub>J-A</sub>, and the ambient temperature, T<sub>A</sub>. The maximum allowable power dissipation at any ambient temperature is calculated using:

$$P_{(MAX)} = \frac{T_J(MAX) - T_A}{\theta_{J-A}}$$

Where the value of θ<sub>J-A</sub> for the DSBGA package is 220°C/W.

### OPERATING RATINGS<sup>(1)</sup>

Temperature Range	-40°C ≤ T <sub>J</sub> ≤ 85°C
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- Absolute Maximum Ratings** indicate limits beyond which damage to the device may occur. **Operating Ratings** indicate conditions for which the device is intended to be functional, but do not ensure specific performance limits. For ensured specifications and test conditions, see the Electrical Characteristics. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed conditions.

## LM3708, LM3709

SNVS149C – NOVEMBER 2000 – REVISED APRIL 2013

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### LM3708/LM3709 SERIES ELECTRICAL CHARACTERISTICS

Limits in the standard typeface are for  $T_J = 25^\circ\text{C}$  and limits in **boldface type** apply over full operating range. Unless otherwise specified:  $V_{CC} = +2.2\text{V}$  to  $5.5\text{V}$ .

Symbol	Parameter	Conditions	Min	Typ	Max	Units	
<b>POWER SUPPLY</b>							
$V_{CC}$	Operating Voltage Range: $V_{CC}$	LM3708	<b>1.0</b>		<b>5.5</b>	V	
		LM3709	<b>1.2</b>		<b>5.5</b>		
$I_{CC}$	$V_{CC}$ Supply Current	All inputs = $V_{CC}$ ; all outputs floating		28	<b>50</b>	$\mu\text{A}$	
<b>RESET THRESHOLD</b>							
$V_{RST}$	Reset Threshold	$V_{CC}$ falling	<b>-0.5</b> <b>-2</b>	$V_{RST}$	<b>+0.5</b> <b>+2</b>	%	
		$V_{CC}$ falling: $T_A = 0^\circ\text{C}$ to $70^\circ\text{C}$	<b>-1.5</b>		<b>+1.5</b>		
$V_{RSTH}$	Reset Threshold Hysteresis			$0.0032 \cdot V_{RST}$		$\text{mV}$	
$t_{RP}$	Reset Timeout Period	Reset Timeout Period = E, J, N, S	<b>1</b>	1.4	<b>2</b>	ms	
		Reset Timeout Period = F, K, P, T	<b>20</b>	28	<b>40</b>		
$t_{RD}$	Reset Timeout Period	Reset Timeout Period = G, L, Q, U	<b>140</b>	200	<b>280</b>	ms	
		Reset Timeout Period = H, M, R, V	<b>1120</b>	1600	<b>2240</b>		
$t_{RD}$	$V_{CC}$ to Reset Delay	$V_{CC}$ falling at $1\text{mV}/\mu\text{s}$		20		$\mu\text{s}$	
<b>RESET (LM3709)</b>							
$V_{OL}$	RESET	$V_{CC} > 2.25\text{V}$ , $I_{SINK} = 900\mu\text{A}$			<b>0.3</b>	V	
		$V_{CC} > 2.7\text{V}$ , $I_{SINK} = 1.2\text{mA}$			<b>0.3</b>		
		$V_{CC} > 4.5\text{V}$ , $I_{SINK} = 3.2\text{mA}$			<b>0.4</b>		
$V_{OH}$	RESET	$V_{CC} > 1.2\text{V}$ , $I_{SOURCE} = 50\mu\text{A}$	<b>0.8 <math>V_{CC}</math></b>			V	
		$V_{CC} > 1.8\text{V}$ , $I_{SOURCE} = 150\mu\text{A}$	<b>0.8 <math>V_{CC}</math></b>				
		$V_{CC} > 2.25\text{V}$ , $I_{SOURCE} = 300\mu\text{A}$	<b>0.8 <math>V_{CC}</math></b>				
		$V_{CC} > 2.7\text{V}$ , $I_{SOURCE} = 500\mu\text{A}$	<b>0.8 <math>V_{CC}</math></b>				
		$V_{CC} > 4.5\text{V}$ , $I_{SOURCE} = 800\mu\text{A}$	<b><math>V_{CC} - 1.5\text{V}</math></b>				
$I_{LKG}$	Output Leakage Current	$V_{RESET} = 5.5\text{V}$			<b>1.0</b>	$\mu\text{A}$	
<b>RESET (LM3708)</b>							
$V_{OL}$	RESET	$V_{CC} > 1.0\text{V}$ , $I_{SINK} = 50\mu\text{A}$			<b>0.3</b>	V	
		$V_{CC} > 1.2\text{V}$ , $I_{SINK} = 100\mu\text{A}$			<b>0.3</b>		
		$V_{CC} > 2.25\text{V}$ , $I_{SINK} = 900\mu\text{A}$			<b>0.3</b>		
		$V_{CC} > 2.7\text{V}$ , $I_{SINK} = 1.2\text{mA}$			<b>0.3</b>		
		$V_{CC} > 4.5\text{V}$ , $I_{SINK} = 3.2\text{mA}$			<b>0.4</b>		
$V_{OH}$	RESET	$V_{CC} > 2.25\text{V}$ , $I_{SOURCE} = 300\mu\text{A}$	<b>0.8 <math>V_{CC}</math></b>			V	
		$V_{CC} > 2.7\text{V}$ , $I_{SOURCE} = 500\mu\text{A}$	<b>0.8 <math>V_{CC}</math></b>				
		$V_{CC} > 4.5\text{V}$ , $I_{SOURCE} = 800\mu\text{A}$	<b><math>V_{CC} - 1.5\text{V}</math></b>				
<b>WDI</b>							
WDI	Watchdog Input Current		<b>-1</b>		<b>+1</b>	$\mu\text{A}$	
WDIT	Watchdog Input Threshold		<b><math>0.2 \cdot V_{CC}</math></b>	1.225	<b><math>0.8 \cdot V_{CC}</math></b>	V	
$t_{WD}$	Watchdog Timeout Period	Watchdog Timeout Period = E, F, G, H	<b>4.3</b>	6.2	<b>9.3</b>	ms	
		Watchdog Timeout Period = J, K, L, M	<b>71</b>	102	<b>153</b>		
		Watchdog Timeout Period = N, P, Q, R	<b>1120</b>	1600	<b>2400</b>	ms	
		Watchdog Timeout Period = S, T, U, V	<b>17900</b>	25600	<b>38400</b>		

### LM3708/LM3709 SERIES ELECTRICAL CHARACTERISTICS (continued)

Limits in the standard typeface are for  $T_J = 25^\circ\text{C}$  and limits in **boldface type** apply over full operating range. Unless otherwise specified:  $V_{CC} = +2.2\text{V}$  to  $5.5\text{V}$ .

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>MR</b>						
$V_{MRT}$	$\overline{MR}$ Input Threshold	$\overline{MR}$ , Low			<b>0.8</b>	V
		$\overline{MR}$ , High	<b>2.0</b>			
$V_{MRTH}$	$\overline{MR}$ Threshold Hysteresis	MR falling: $V_{CC} = V_{RST}$ MAX to $5.5\text{V}$		$0.0032 \cdot V_{RST}$		mV
$R_{MR}$	$\overline{MR}$ Pull-up Resistance		<b>35</b>	56	<b>75</b>	k $\Omega$
$t_{MD}$	$\overline{MR}$ to Reset Delay			12		$\mu\text{s}$
$t_{MR}$	$\overline{MR}$ Pulse Width		<b>25</b>			$\mu\text{s}$
<b>LLO</b>						
$V_{OL}$	LLO Output Voltage	$V_{CC} > 2.25\text{V}$ , $I_{SINK} = 900\mu\text{A}$			<b>0.3</b>	V
		$V_{CC} > 2.7\text{V}$ , $I_{SINK} = 1.2\text{mA}$			<b>0.3</b>	
		$V_{CC} > 4.5\text{V}$ , $I_{SINK} = 3.2\text{mA}$			<b>0.4</b>	
$V_{OH}$		$V_{CC} > 2.25\text{V}$ , $I_{SOURCE} = 300\mu\text{A}$	<b>0.8</b> $V_{CC}$			
		$V_{CC} > 2.7\text{V}$ , $I_{SOURCE} = 500\mu\text{A}$	<b>0.8</b> $V_{CC}$			
		$V_{CC} > 4.5\text{V}$ , $I_{SOURCE} = 800\mu\text{A}$	$V_{CC} - 1.5\text{V}$			
<b>LLO OUTPUT</b>						
$V_{LLOT}$	LLO Output Threshold ( $V_{LLO} - V_{RST}$ , $V_{CC}$ falling)		<b>1.01</b> $\cdot V_{RST}$	$1.02 \cdot V_{RST}$	<b>1.03</b> $\cdot V_{RST}$	V
$V_{LLOTH}$	Low-Line Comparator Hysteresis			$0.0032 \cdot V_{RST}$		mV
$t_{CD}$	Low-Line Comparator Delay	$V_{CC}$ falling at $1\text{mV}/\mu\text{s}$		20		$\mu\text{s}$

### TYPICAL PERFORMANCE CHARACTERISTICS

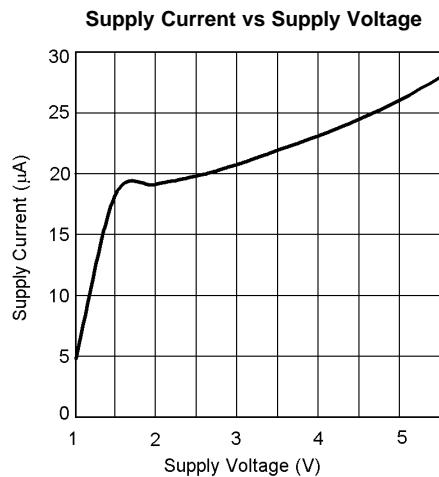


Figure 2.

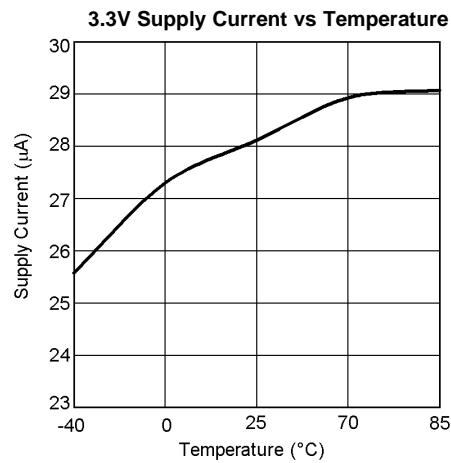


Figure 3.

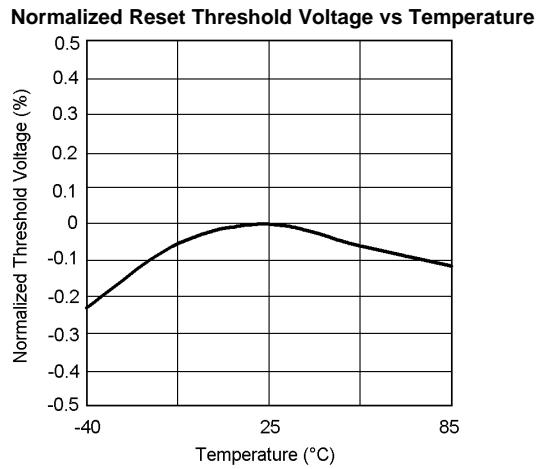


Figure 4.

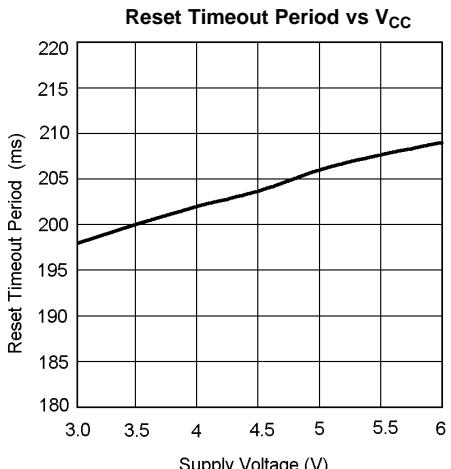


Figure 5.

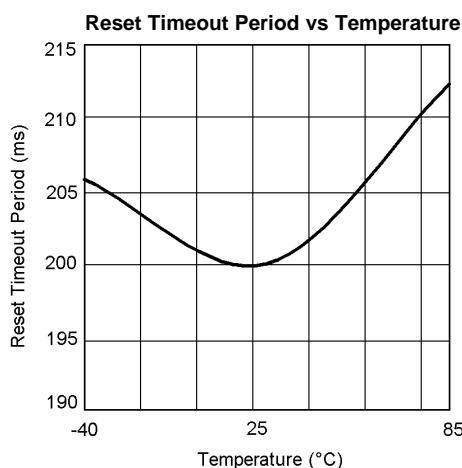


Figure 6.

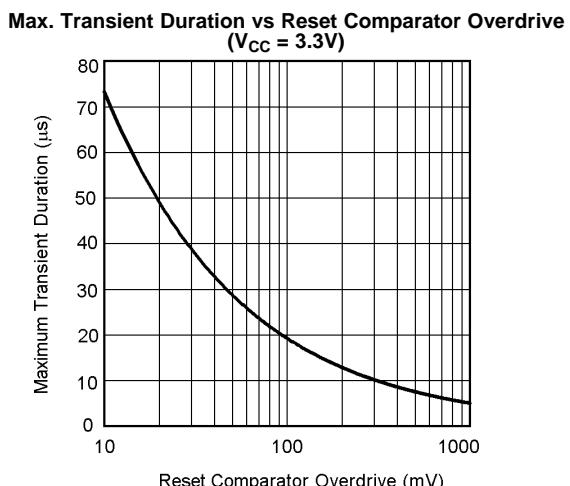
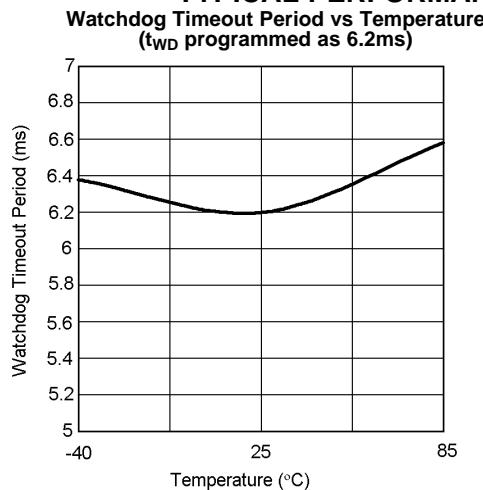
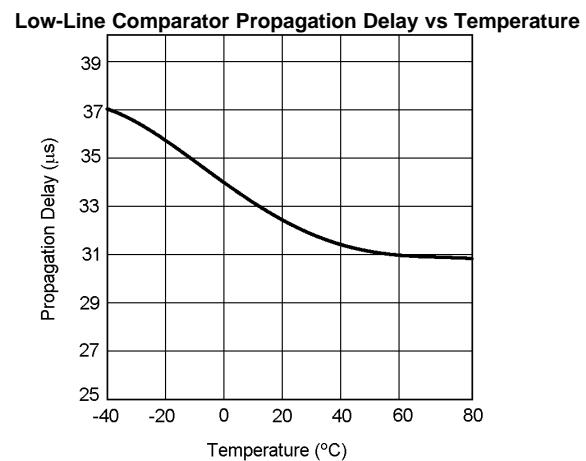


Figure 7.

**TYPICAL PERFORMANCE CHARACTERISTICS (continued)**



**Figure 8.**



**Figure 9.**

## CIRCUIT INFORMATION

### Reset Output

The Reset input of a  $\mu$ P initializes the device into a known state. The LM3708/LM3709 microprocessor supervisory circuits assert a forced reset output to prevent code execution errors during power-up, power-down, and brownout conditions.

RESET is ensured valid for  $V_{CC} > 1V$ . Once  $V_{CC}$  exceeds the reset threshold, an internal timer maintains the output for the reset timeout period. After this interval, reset goes high. The LM3708 offers an active-low RESET; The LM3709 offers an active-high RESET.

Any time  $V_{CC}$  drops below the reset threshold (such as during a brownout), the reset activates. When  $V_{CC}$  again rises above the reset threshold, the internal timer starts. Reset holds until  $V_{CC}$  exceeds the reset threshold for longer than the reset timeout period. After this time, reset releases.

The Manual Reset input ( $\overline{MR}$ ) will initiate a forced reset also. See the [Manual Reset Input \( \$\overline{MR}\$ \)](#) section.

### Reset Threshold

The LM3708/LM3709 family is available with a reset voltage of 3.08V. Other reset thresholds in the 2.20V to 5.0V range, in steps of 10 mV, are available; contact TI for details.

### Manual Reset Input ( $\overline{MR}$ )

Many  $\mu$ P-based products require a manual reset capability, allowing the operator to initiate a reset. The  $\overline{MR}$  input is fully debounced and provides an internal 56 k $\Omega$  pull-up. When the  $\overline{MR}$  input is pulled below  $V_{MRT}$  (1.225V) for more than 25  $\mu$ s, reset is asserted after a typical delay of 12  $\mu$ s. Reset remains active as long as  $\overline{MR}$  is held low, and releases after the reset timeout period expires after  $\overline{MR}$  rises above  $V_{MRT}$ . Use  $\overline{MR}$  with digital logic to assert or to daisy chain supervisory circuits. It may be used as another low-line comparator by adding a buffer.

### Low-Line Output ( $\overline{LLO}$ )

The low-line output comparator is typically used to provide a non-maskable interrupt to a  $\mu$ P when  $V_{CC}$  begins falling.  $\overline{LLO}$  monitors  $V_{CC}$  and goes low when  $V_{CC}$  falls below  $V_{LLOT}$  (typically  $1.02 \cdot V_{RST}$ ) with hysteresis of  $0.0032 \cdot V_{RST}$ .

### Watchdog Timer Input (WDI)

The watchdog timer input monitors one of the microprocessor's output lines for activity. Each time a transition occurs on this monitored line, the watchdog counter is reset. However, if no transition occurs and the timeout period is reached, the LM3708/LM3709 assumes that the microprocessor has locked up and the reset output is activated.

WDI is a high impedance input.

### Special Precautions for the DSBGA Package

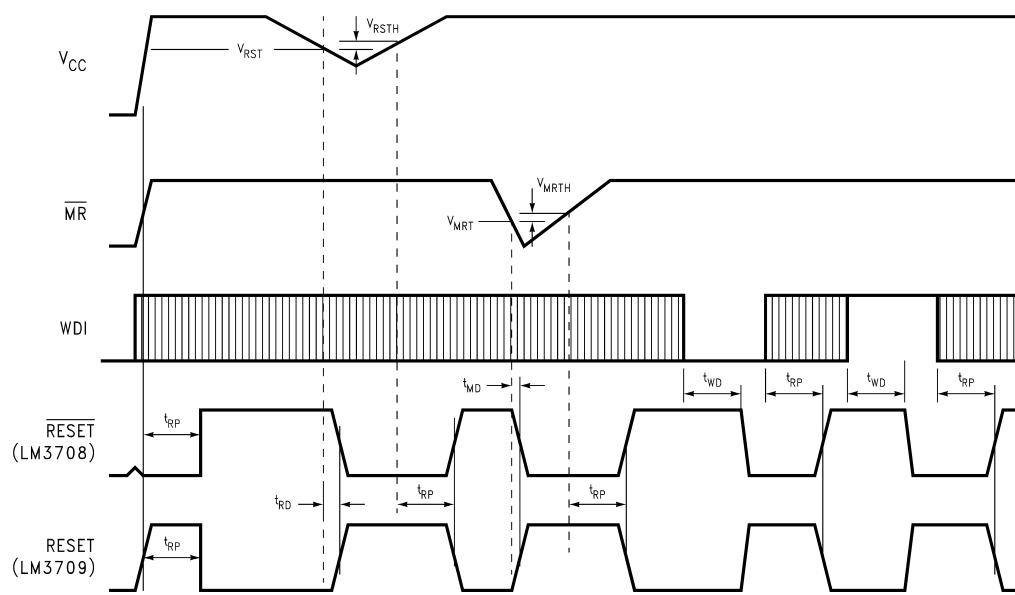
As with most integrated circuits, the LM3708 and LM3709 are sensitive to exposure from visible and infrared (IR) light radiation. Unlike a plastic encapsulated IC, the DSBGA package has very limited shielding from light, and some sensitivity to light reflected from the surface of the PC board or long wavelength IR entering the die from the side may be experienced. This light could have an unpredictable affect on the electrical performance of the IC. Care should be taken to shield the device from direct exposure to bright visible or IR light during operation.

### DSBGA Mounting

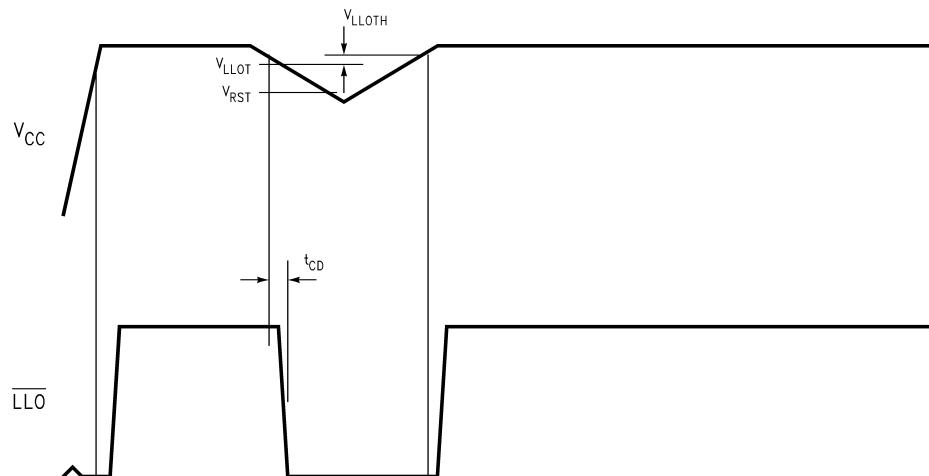
The DSBGA package requires specific mounting techniques which are detailed in TI Application Note AN-1112. Referring to the section **Surface Mount Technology (SMT) Assembly Considerations**, it should be noted that the pad style which must be used with the 9-pin package is the NSMD (non-solder mask defined) type.

For best results during assembly, alignment ordinals on the PC board may be used to facilitate placement of the DSBGA device.

### Timing Diagrams

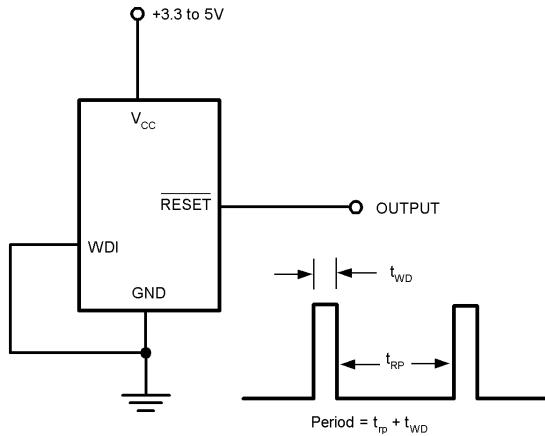


**Figure 10. LM3708 Reset Time with  $\overline{MR}$  and WDI**



**Figure 11.  $\overline{LLO}$  Output**

**Typical Application Circuit**



**Figure 12. Long Delay Timer/Oscillator**

**REVISION HISTORY**

<b>Changes from Revision B (April 2013) to Revision C</b>	<b>Page</b>
• Changed layout of National Data Sheet to TI format .....	10

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Products	Applications
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Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>
DLP® Products	<a href="http://www.dlp.com">www.dlp.com</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>
Clocks and Timers	<a href="http://www.ti.com/clocks">www.ti.com/clocks</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>
RFID	<a href="http://www.ti-rfid.com">www.ti-rfid.com</a>
OMAP Applications Processors	<a href="http://www.ti.com/omap">www.ti.com/omap</a>
Wireless Connectivity	<a href="http://www.ti.com/wirelessconnectivity">www.ti.com/wirelessconnectivity</a>
	<b>TI E2E Community</b>
	<a href="http://e2e.ti.com">e2e.ti.com</a>